

## Thermal Gel 21-361-SP02

## 🖺 FEATURES & BENEFITS

- Thermal Conductivity: 6.0 W/m-K
- High Reliability
- Easily Dispensable
- Pre-Cured
- Electrically Isolating
- Low Thermal Resistance

## **APPLICATIONS**

- Cooling components to chassis, frame, or other mating components
- Memory modules
- Mass storage devices
- Automotive electronics
- Telecommunication hardware
- Power electronics
- LCD and PDP flat panel
- Audio and video component
- IT infrastructure

- M

• GPS navigation and other portable devices

**TYPICAL PROPERTIES** 



JONES Thermal Gel 21-361-SP02 is a soft, single part, silicone putty thermal gap filler in which no cure is required. This gap filler is designed to be used in where large gap tolerances are present and low mechanical stress on delicate components are needed. It is ideal for filling variable gaps between multiple components and a common heat sink.

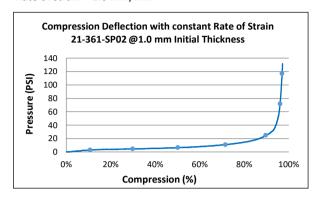
JONES Thermal Gel 21-361-SP02 has a composition which yields superior thermal performance and super compliancy. This material transfers little to no pressure between interfaces. Specialized rheology allows for easy flow under pressure.

Properties		Thermal Gel 21-361-SP02	Test Method
Thermal	Thermal Conductivity (W/m·K)	6.0	ASTM D5470
	Thermal Resistance (°C.cm^2/W) @1mm	-	ASTM D5470
	Operating Temperature Range (°C)	-55~150	JONES Test Method
Physical	Color	Pink	Visual
	Composition	Ceramic & Silicone	-
	Density (g/cc)	3.4	ASTM D792
	Flow Rate (g/min)	25	90 Psi,EFD50cc @ Ø2.41mm nozzle
	Typical Minimum Bondline Thickness (mm)	0.15	JONES Test Method
Electrical	Breakdown Voltage (KV AC /mm)	> 6	ASTM D149
	Volume Resistivity (Ohm·cm)	10^13	ASTM D257
	Dielectric Constant @1MHz	11.0	ASTM D150
Regulatory	Flammability Rating	V0	UL 94

### **TEST RESULTS**

21-361-SP02 Thermal Gel 1.0 mm Initial Thickness; 1 inch^2 Specimen Area;

**Compression Deflection** Rate of strain = 1.0 mm/min



# PART NUMBER SYSTEM

**(4)** 

<u>21 - 3 XX - AB - YYY</u>

2 3

① 21-Thermal management material

(1)

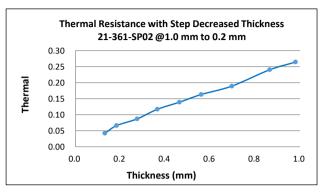
2 3- Thermal Gel

④ AB- Optional style

⑤ YYY- Package Size

## Thermal Resistance

Decreased Thickness step = 0.2 mm



## CRDERING INFORMATION

#### Part Number Examples

21-361-SP02-010-800G=Thermal Gel 21-361-SP02 in a 300 CC Cartridge (800 g)

21-361-SP02-080-25KG=Thermal Gel 21-361-SP02 in a 5 Gallon Pail(25 Kg)

Customizable packaging

#### **Storage Requirement**

0°C to 35°C, 50%RH, sealing preservation

- 6 months from date of manufacture.
- \* Unopened Original Package

6 months from date of manufacture.

#### HANDLING PRECAUTIONS

③ XX- Thermal Performance

FOR SAFE HANDLING INFORMATION OF THIS PRODUCT, PLEASE CONTACT WITH YOUR JONES REPRESENTATIVE FOR THE SAFETY DATA SHEET (SDS).

#### LIMITED WARRANTY INFORMATION

#### FOR MORE INFORMATION

About our high performance materials, solutions and capabilities, please visit our website:

http://www.jones-corp.com

Disclaimer

• The information provided in this Technical Data Sheet (TDS) including the recommendations for use and application of the product are based on our knowledge and experience of the product as at the issuing date of this TDS. When using our products, no matter what type of equipment they might be used for, be sure to make a written agreement on the specifications with us in advance. The design and specifications in this TDS are subject to change without prior notice.

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Do not use the products beyond the specifications described in this TDS. This TDS explains the typical performance of the products as individual component.
Before use, check and evaluate their operations when installed in your products.

The product provided in this TDS compliance with HSF.

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